

DS80EP100

DS80EP100 5 to 12.5 Gbps, Power-Saver Equalizer for Backplanes and Cables



Literature Number: SNLS279B

DS80EP100

5 to 12.5 Gbps, Power-Saver Equalizer for Backplanes and Cables

General Description

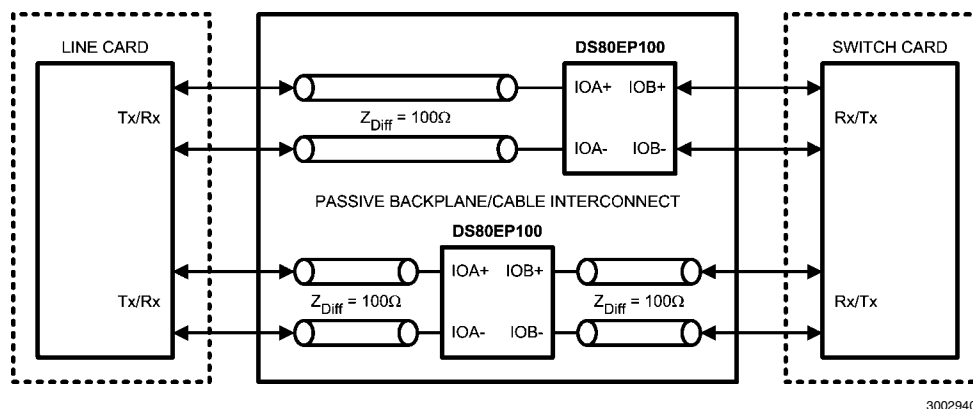
National's Power-saver equalizer compensates for transmission medium losses and minimizes medium-induced deterministic jitter. Performance is guaranteed over the full range of 5 to 12.5 Gbps. The DS80EP100 requires no power to operate. The equalizer operates anywhere in the data path to minimize media-induced deterministic jitter in both FR4 traces and cable applications. Symmetric I/O structures support full duplex or half duplex applications. Linear compensation is provided independent of line coding or protocol. The device is ideal for both bi-level and multi-level signaling.

The equalizer is available in a 6 pin leadless LLP package with a space saving 2.2 mm X 2.5 mm footprint. This tiny package provides maximum flexibility in placement and routing of the Power-saver equalizer.

Features

- 5 to 12.5 Gbps Operation
- No Power or Ground Required
- Equalization effective anywhere in data path
- Equalizes CML, LV-PECL, LVDS signals
- Symmetric I/O structures provide equal boost for bi-directional operation
- 7 dB Maximum Boost
- Code independent, 8b/10b or Scrambled
- Supports both bi-level and multi-level signaling
- Extends reach over backplanes and cables
- Compatible with PCI-Express Gen1 and Gen2
- Compatible with XAUI
- Will operate in series with existing active Equalizer
- Easy to handle 6 pin LLP

Simplified Application Diagram



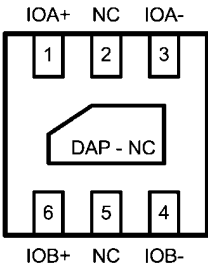
Note: The DS80EP100 provides the flexibility of passing the data from either side of the device. It can be placed anywhere in the data path.

Pin Descriptions

Pin Name	Pin Number	I/O Type	Description
High speed differential I/O			
IOA-	3	I/O	Symmetric differential I/O
IOA+	1		
IOB-	4	I/O	Symmetric differential I/O
IOB+	6		
NC Exposed Pad	2, 5 DAP	N/A	Reserved. Do not connect.

Note: I = Input / O = Output

Connection Diagram



30029405
Bottom View Shown
2.2mm x 2.5mm 6-Pin LLP Package
Order Number DS80EP100
See NS Package Number SDA14A

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

INPUT/OUTPUT

(IOA+ and IOB+) or (IOA- and IOB-) +2V

(IOA+ and IOA-) or (IOB+ and IOB-) +4V

(IOA+ and IOB-) or (IOA- and IOB+) +4V

Junction Temperature +150°C

Storage Temperature -65°C to +150°C

Lead Temperature

Soldering, 4 sec

+260°C

ESD Rating

HBM, 1.5 k Ω , 100 pF

1.3kV

Recommended Operating Conditions

	Min	Typ	Max	Units
Ambient Temperature	-40	25	+85	°C
Bit Rate	5		12.5	Gbps

Electrical Characteristics (Note 6)

Over recommended operating conditions unless other specified. All parameters are guaranteed by test, statistical analysis or design.

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_{IN}	Input voltage swing	(Note 3)		1000	3600	mVp-p
	Equalization	6.25 GHz relative to 100MHz		6		dB
R_{LI}	Differential input return loss	100 MHz – 6.25 GHz, with fixture's effect de-embedded		15		dB
R_{LO}	Differential output return loss	100 MHz – 6.25 GHz, with fixture's effect de-embedded IOA+, or IOB+ = static high.		15		dB
R_{IN}	Input Impedance	Differential across IOA+ and IOA-, or IOB+ and IOB-, ZLOAD = 100 Ω		100		Ω
R_O	Output Impedance	Differential across IOA+ and IOA-, or IOB+ and IOB-, ZSOURCE = 100 Ω		100		Ω
	Through Response	Relative to ideal load, see Figure 2 for setup	See Figure 3 and Table 1 for limits			
R1	Resistance IOA+ to IOA- and IOB+ to IOB-	No load, high impedance on all ports		150		Ω
R2	Resistance IOA+ to IOB+ and IOA- to IOB-	No load, high impedance on all ports		50		Ω
R3	Resistance IOA+ to IOB- and IOA- to IOB+	No load, high impedance on all ports		150		Ω
	DC Gain (IOA/IOB or IOB/IOA)	ZLOAD = 100 Ω		0.4		
DJ1	Residual deterministic jitter	5 Gbps, 20 in of 6mil microstrip FR4 See (Note 4)		0.15		Ulp-p
DJ2	Residual deterministic jitter	6.25 Gbps, 20 in of 6mil microstrip FR4 See (Notes 4, 5)		0.15	0.20	Ulp-p
DJ3	Residual deterministic jitter	8 Gbps, 20 in of 6mil microstrip FR4 See (Notes 4, 5)		0.15	0.20	Ulp-p
DJ4	Residual deterministic jitter	10 Gbps, 20 in of 6mil microstrip FR4 See (Note 4)		0.15		Ulp-p
DJ5	Residual deterministic jitter	12.5 Gbps, 14 in of 6mil microstrip FR4 See (Note 4)		0.15		Ulp-p

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions.

Note 2: Typical values represent most likely parametric norms, $T_A = +25\text{ degC}$, and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

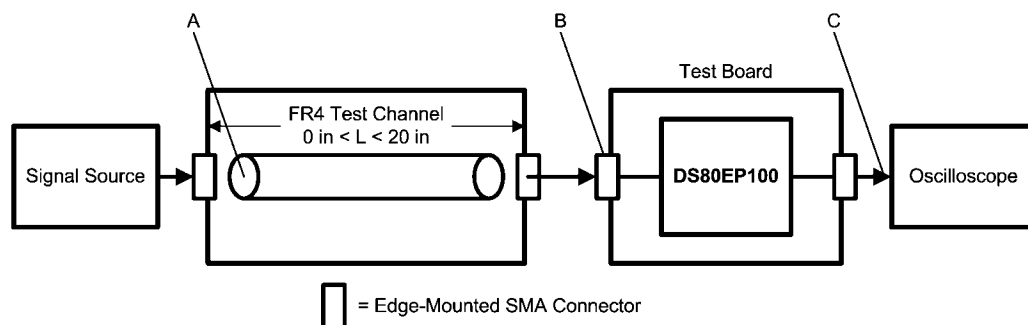
Note 3: Differential signal to Equalizer, measured at the input to a transmission line, see point A of *Figure 1*. The transmission line is $Z_0 = 100\Omega$, 6-mil, microstrip in FR4 material.

Note 4: Deterministic jitter is measured at the differential outputs (point C of *Figure 1*), minus the deterministic jitter before the test channel (point A of *Figure 1*). Test pattern: PRBS- 7 .

Note 5: Specification is guaranteed by characterization and is not tested in production.

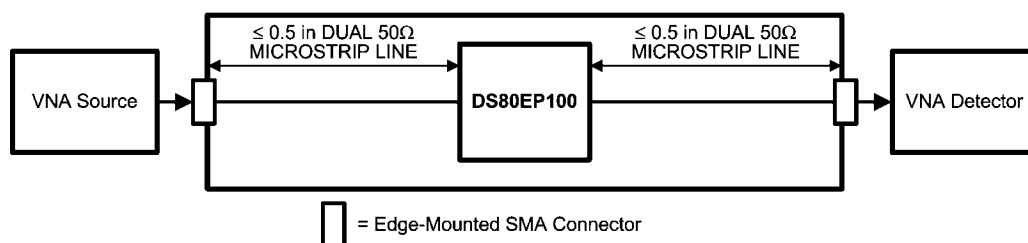
Note 6: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Test Setup Diagrams



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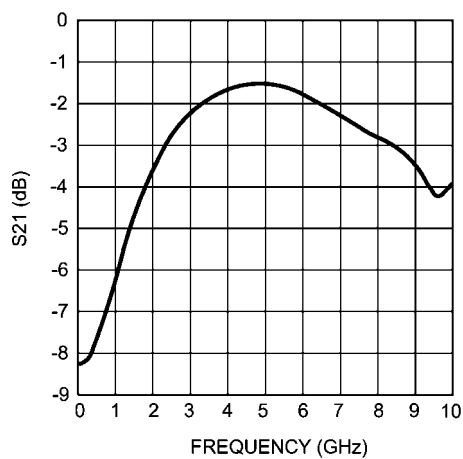
FIGURE 1. Transient Test Setup Diagram



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FIGURE 2. Frequency Response Test Circuit

Typical Equalizer Transfer Function

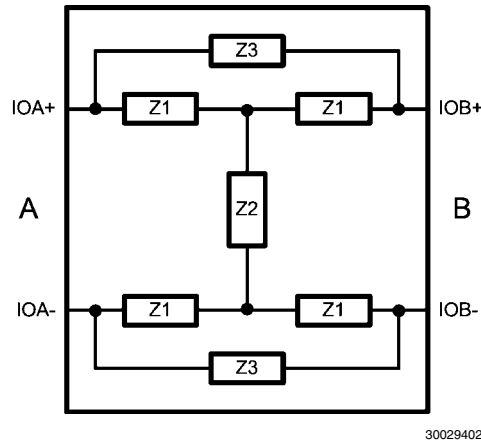


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FIGURE 3. Typical Equalizer Transfer Function

Table 1. Typical Through Response

Frequency (GHz)	DS80EP100 Attenuation Typ (dB)
0.1	-8.25
0.5	-7.64
1	-6.12
1.5	-4.68
2	-3.57
3	-2.22
4	-1.66
5	-1.53
6	-1.77
7	-2.28
8	-2.8
9	-3.47
10	-3.91

Block Diagram

30029402

FIGURE 4. Simplified Block Diagram**Application Information****DS80EP100 DEVICE DESCRIPTION**

The DS80EP100 Power-Saver equalizer is a passive network circuit composed of resistive, capacitive, and inductive components (See *Figure 4*). A Differential bridged T-network compensates for the transmission medium losses and minimizes medium-induced deterministic jitter with FR4 and cables. The equalizer attenuates low frequency signals and is a bandpass filter at the resonant frequency. The response is linear and symmetric.

I/O TERMINATIONS

The DS80EP100 I/O impedance is 100Ω differential. The equalizer is designed for 100Ω-balanced differential signals and is not intended for single-ended transmission.

LINEAR COMPENSATION

The unique linear compensation feature of the DS80EP100 combined with the tiny package allows maximum flexibility in placement. The equalizer can be placed anywhere in the data

path and will provide the same compensation at the receiving circuit. (See Simplified Application Diagram)

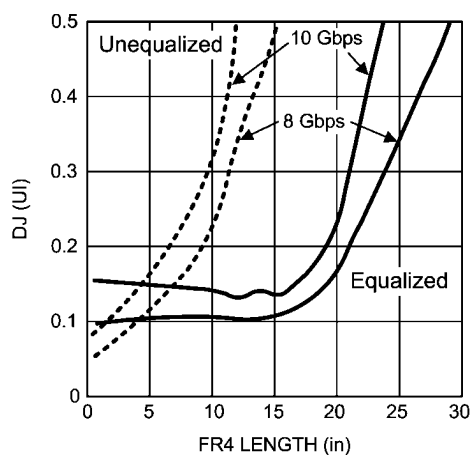
SYMMETRIC I/O STRUCTURES

The symmetry of the passive equalization network allows bi-directional operation. Signals receive equal compensation regardless of the direction of data flow. (See Simplified Block Diagram).

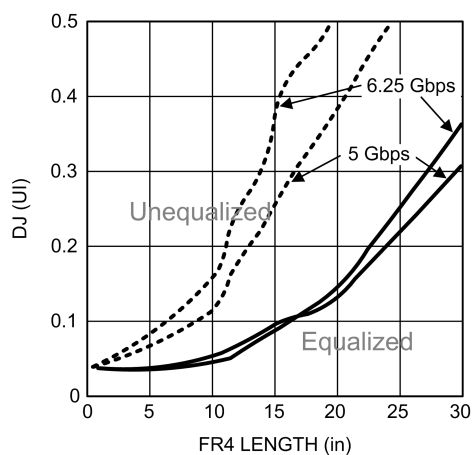
PCB LAYOUT CONSIDERATIONS FOR DIFFERENTIAL PAIRS AND NO CONNECT PADS

The differential I/Os must have a controlled differential impedance of 100Ω. It is preferable to route all differential lines exclusively on one layer of the board. The use of vias should be avoided if possible. If vias must be used, they should be used sparingly and must be placed symmetrically for each side of a given differential pair. Differential signals should be routed away from other signals and noise sources on the printed circuit board. Pin 2, Pin 5, and the center DAP have to be left as no connect. Therefore, do not connect the landing pads of these pins to the power or ground plane. See AN-1187 for additional information on the LLP package.

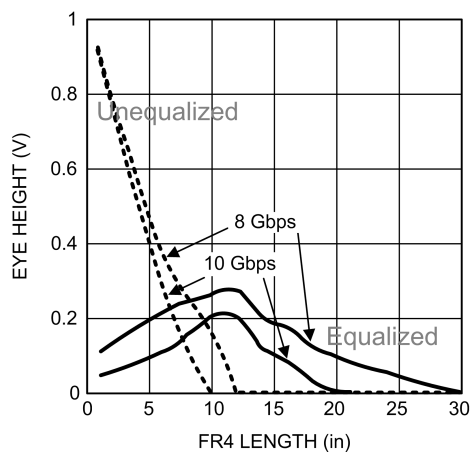
Typical Performance Characteristics



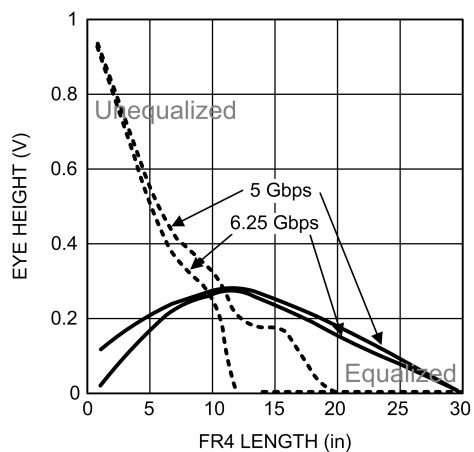
Residual Deterministic Jitter vs. FR4 Length 30029407



Residual Deterministic Jitter vs. FR4 Length 30029408

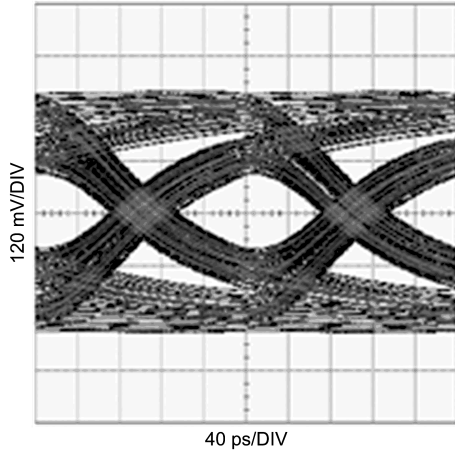


Eye Height vs. FR4 Length 30029409



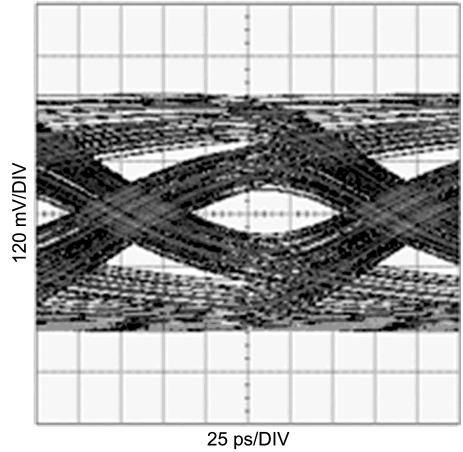
Eye Height vs. FR4 Length 30029410

Typical Eye Diagrams — Includes Transmitter Setup, Interconnect, and Device Total Jitter



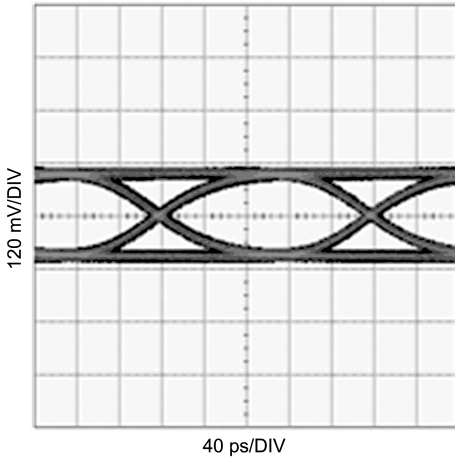
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FIGURE 5. Unequalized Signal (20in FR4, 5Gbps, PRBS7)



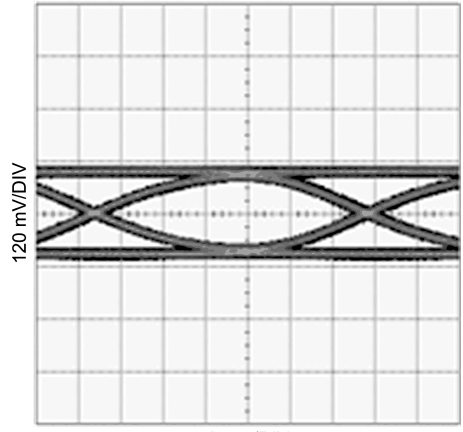
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FIGURE 8. Unequalized Signal (20in FR4, 6.25Gbps, PRBS7)



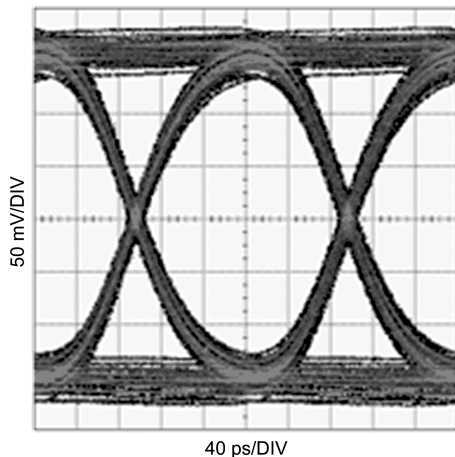
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FIGURE 6. Equalized Signal (20in FR4, 5Gbps, PRBS7)



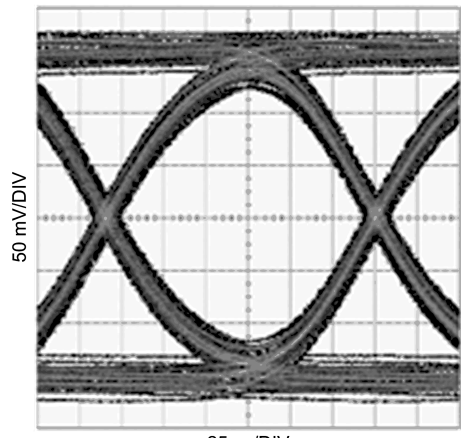
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FIGURE 9. Equalized Signal (20in FR4, 6.25Gbps, PRBS7)



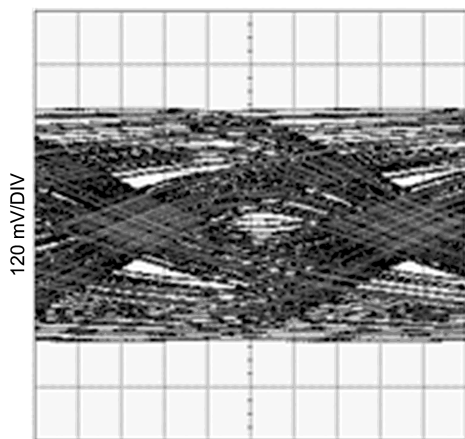
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FIGURE 7. Equalized Signal (Zoom) (20in FR4, 5Gbps, PRBS7)



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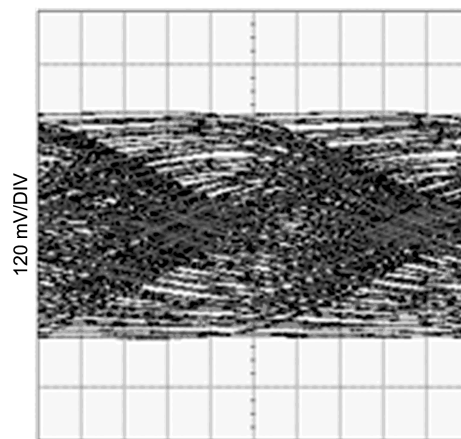
FIGURE 10. Equalized Signal (Zoom) (20in FR4, 6.26Gbps, PRBS7)



20 ps/DIV

30029417

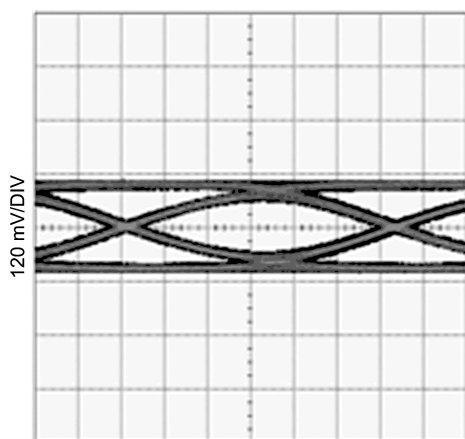
FIGURE 11. Unequalized Signal (20in FR4, 8Gbps, PRBS7)



20 ps/DIV

30029420

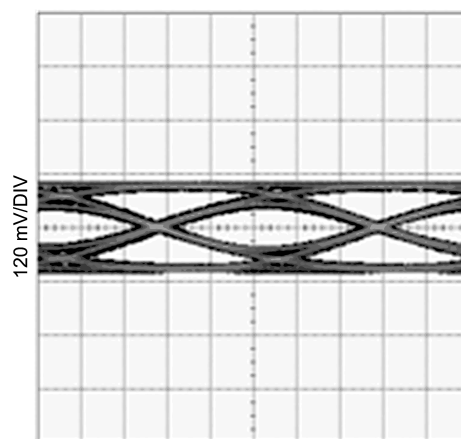
FIGURE 14. Unequalized Signal (20in FR4, 10Gbps, PRBS7)



20 ps/DIV

30029418

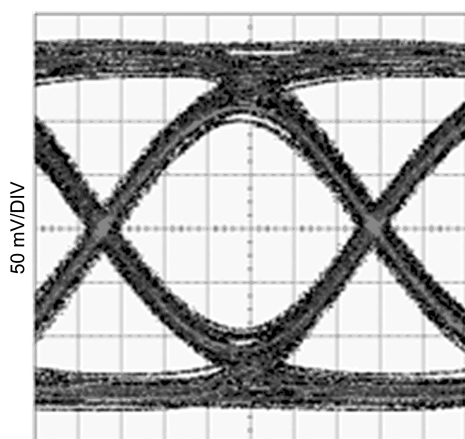
FIGURE 12. Equalized Signal (20in FR4, 8Gbps, PRBS7)



20 ps/DIV

30029421

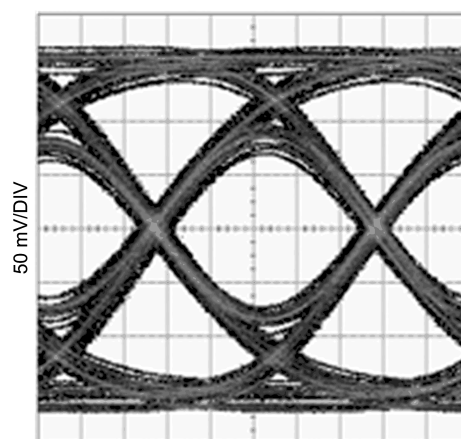
FIGURE 15. Equalized Signal (20in FR4, 10Gbps, PRBS7)



20 ps/DIV

30029419

FIGURE 13. Equalized Signal (Zoom) (20in FR4, 8Gbps, PRBS7)



20 ps/DIV

30029422

FIGURE 16. Equalized Signal (Zoom) (20in FR4, 10Gbps, PRBS7)

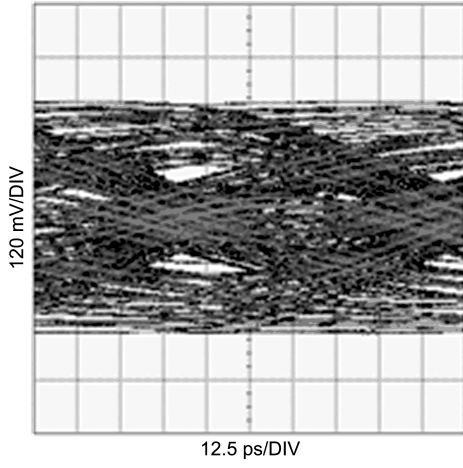


FIGURE 17. Unequalized Signal (14in FR4, 12.5Gbps, PRBS7)

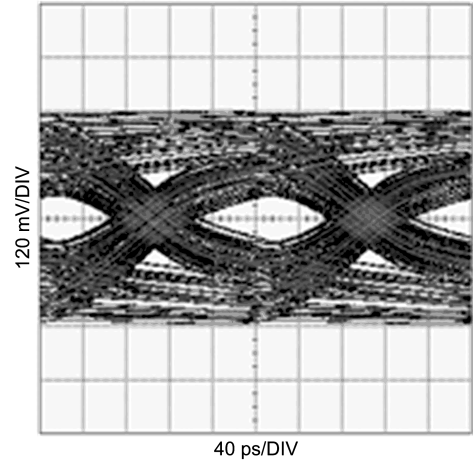


FIGURE 20. Unequalized Signal (5m 26AWG Twin-AX Cable, 5Gbps, PRBS7)

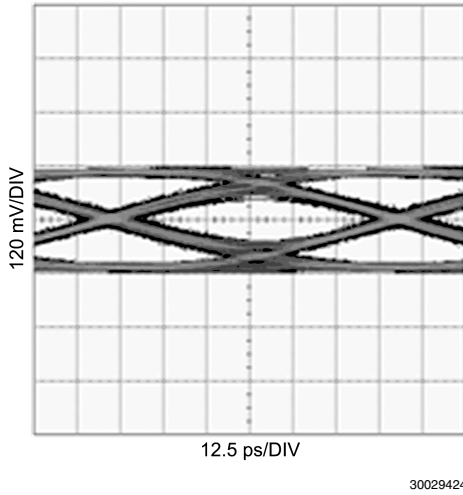


FIGURE 18. Equalized Signal (14in FR4, 12.5Gbps, PRBS7)

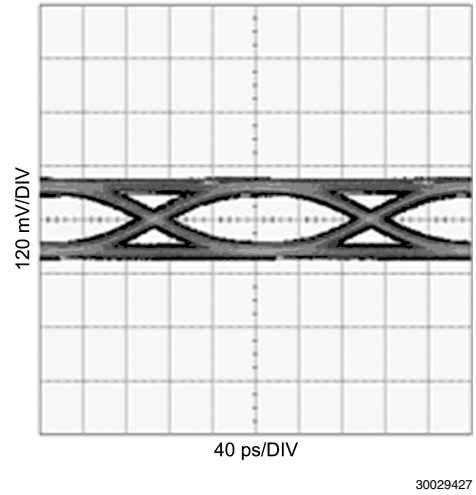


FIGURE 21. Equalized Signal (5m 26AWG Twin-AX Cable, 5Gbps, PRBS7)

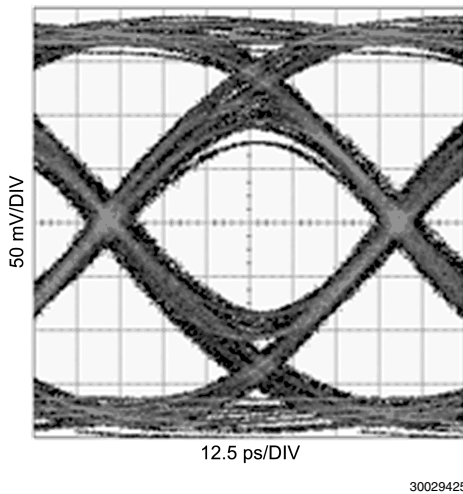


FIGURE 19. Equalized Signal (Zoom) (14in FR4, 12.5Gbps, PRBS7)

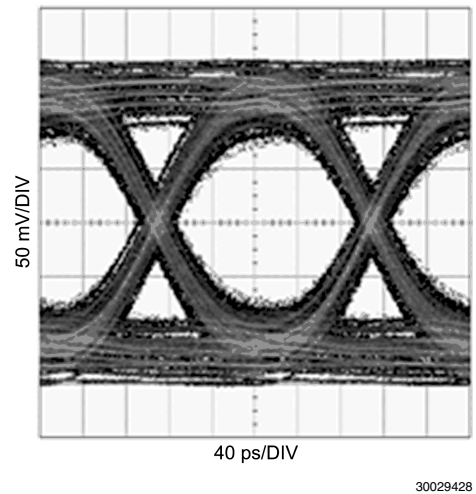
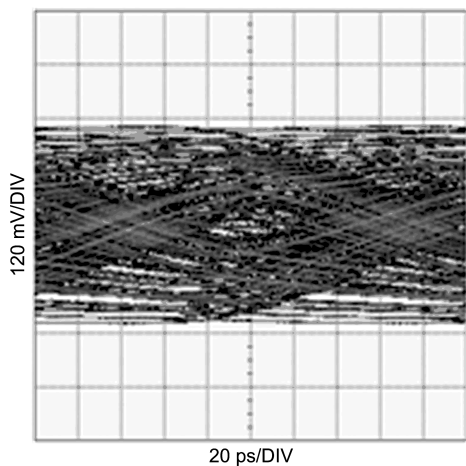
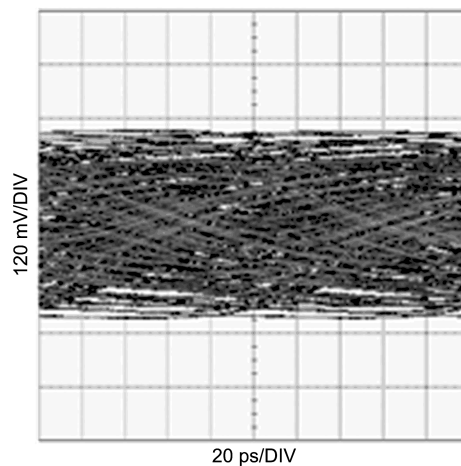


FIGURE 22. Equalized Signal (Zoom) (5m 26AWG Twin-AX Cable, 5Gbps, PRBS7)



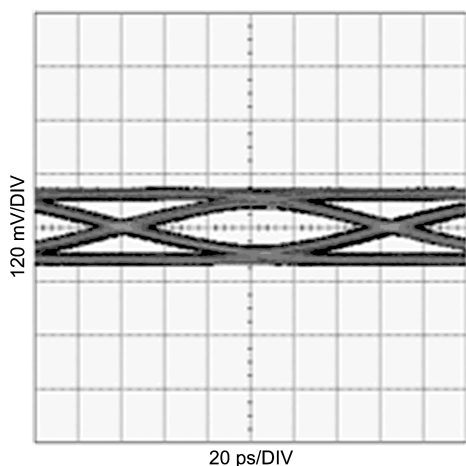
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FIGURE 23. Unequalized Signal (5m 26AWG Twin-AX Cable, 8Gbps, PRBS7)



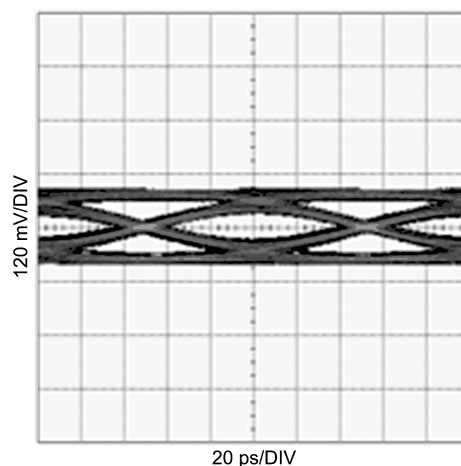
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FIGURE 26. Unequalized Signal (5m 26AWG Twin-AX Cable, 10Gbps, PRBS7)



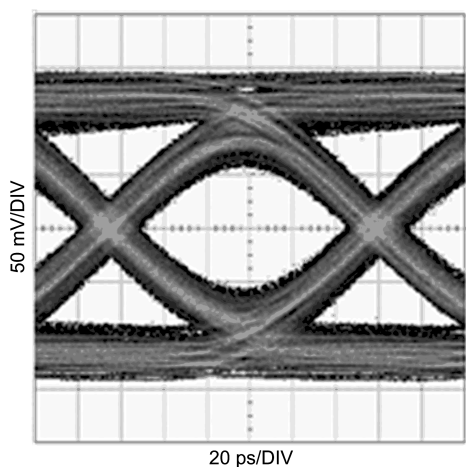
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FIGURE 24. Equalized Signal (5m 26AWG Twin-AX Cable, 8Gbps, PRBS7)



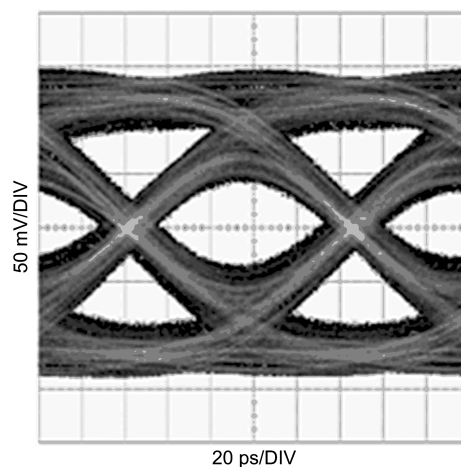
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FIGURE 27. Equalized Signal (5m 26AWG Twin-AX Cable, 10Gbps, PRBS7)



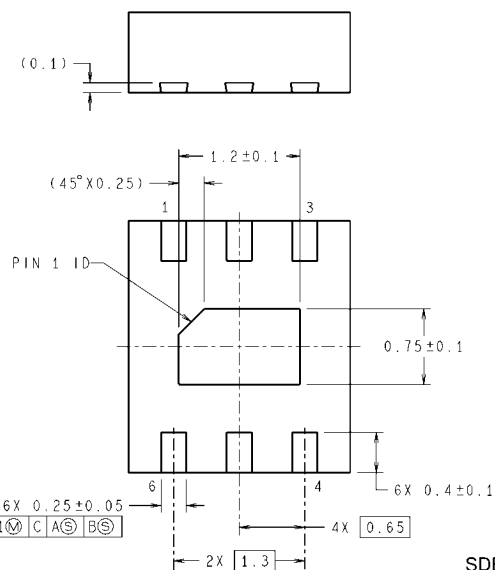
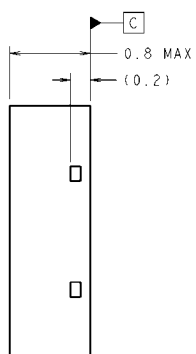
30029431

FIGURE 25. Equalized Signal (Zoom) (5m 26AWG Twin-AX Cable, 8Gbps, PRBS7)



30029434

FIGURE 28. Equalized Signal (Zoom) (5m 26AWG Twin-AX Cable, 10Gbps, PRBS7)



SDB06A (Rev A)

Order Number DS80EP100
See NS Package SDB06A

Notes

Notes

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